



AUTOMATED CHEMICAL SOLUTIONS

Chemicals and Controllers for PWB Fabrication

Product Overview

μETCH ME-2240

Copper Microetch

Product Description

ME-2240 is a potassium monopersulfate based microetch. ME-2240 provides superior surface topography and extended bath life when compared to generic sodium persulfate microetch.

Physical Properties

Specific gravity: 1.1-1.4
Appearance: white, granular solid
Odor: none

Bath Make-Up

30 – 120 g/L μETCH ME-2240
2% v/v sulfuric acid
Balance DI water

Operating Parameters

Copper loading: 2 - 4 oz/gal (15 – 37.5 g/L)
Dwell time: 1 – 2 minutes
Temperature: 80 °F – 110 °F

Storage

Store in original containers above 40 °F.

Safety

Avoid contact with eyes, skin and clothing. Wear chemical handler's gloves, goggles and protective clothing when handling. Read and understand Material Safety Data Sheet before using this product.

Notice

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